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## FDN86246 N-Channel PowerTrench<sup>®</sup> MOSFET 150 V, 1.6 A, 261 m $\Omega$

#### Features

- Max r<sub>DS(on)</sub> = 261 mΩ at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 1.6 A
- Max  $r_{DS(on)}$  = 359 m $\Omega$  at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 1.4 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL tested
- RoHS Compliant

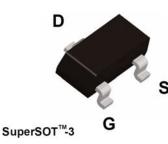


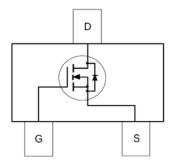
## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been optimized for  $r_{DS(on)}$ , switching performance and ruggedness.

### Application

PD Switch





### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		150	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
1	-Continuous	(Note 1a)	1.6	٨
D	-Pulsed		6	— A
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	13	mJ
D	Power Dissipation	(Note 1a)	1.5	w
P <sub>D</sub>	Power Dissipation	(Note 1b)	0.6	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	75	°C/M
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	80	°C/W

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
246	FDN86246	SSOT-3	7 "	8 mm	3000 units

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December 2010

ΔT <sub>J</sub> DSS GSS	Breakdown Voltage Temperature	$I_{D}$ = 250 $\mu$ A, $V_{GS}$ = 0 V	150			V
oss oss	Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		106		mV/°C
SS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA
	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
n Characi	teristics (Note 2)	00 00				
	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2	3.4	4	V
	Gate to Source Threshold Voltage		_	-		
<u>00(ui</u> )	Temperature Coefficient	$I_{D}$ = 250 $\mu A,$ referenced to 25 °C		-9		mV/°0
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.6 A		195	261	
DS(on)	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 1.4 A		242	359	mΩ
		$V_{GS}$ = 10 V, I <sub>D</sub> = 1.6 A, T <sub>J</sub> = 125 °C		359	481	
FS	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.6 A		4		S
vnamic C	haracteristics					
-	Input Capacitance			168	225	pF
	Output Capacitance	V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		21	30	pF
	Reverse Transfer Capacitance			1.6	5	pF
	Gate Resistance			0.9		Ω
•	Characteristics					
-	Characteristics			4 5	10	
	Turn-On Delay Time			4.5	10	ns
	Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 1.6 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		1.1	10	ns
	Turn-Off Delay Time	$v_{GS} = 10 v, R_{GEN} = 0.02$		8	16	ns
	Fall Time			2.9	10	ns
9	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		2.9	5	nC
9	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V,$ $I_{D} = 1.6 A$		1.6	3	nC
90	Gate to Source Gate Charge	I <sub>D</sub> = 1.6 A		0.9		nC
) <sub>gd</sub>	Gate to Drain "Miller" Charge			0.8		nC
rain-Sour	ce Diode Characteristics					
SD	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 1.6 A (Note 2)		0.83	1.3	V
	Reverse Recovery Time	I <sub>E</sub> = 1.6 A, di/dt = 100 A/μs		44	70	ns
۵ <sub>rr</sub>	Reverse Recovery Charge	$I_{\rm F} = 1.0$ A, di/dt = 100 A/µs		29	47	nC

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Symbol Parameter

**Electrical Characteristics** T<sub>J</sub> = 25 °C unless otherwise noted

Off Characteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		106		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V			±100	nA

**Test Conditions** 

Min

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Max

Units

#### On

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	2	3.4	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		-9		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.6 A		195	261	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 1.4 A		242	359	mΩ
		$V_{GS}$ = 10 V, I <sub>D</sub> = 1.6 A, T <sub>J</sub> = 125 °C		359	481	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.6 A		4		S
	- Chave stavistics					

#### Dyn

C <sub>iss</sub>	Input Capacitance		168	225	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz	21	30	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		1.6	5	pF
R <sub>g</sub>	Gate Resistance		0.9		Ω

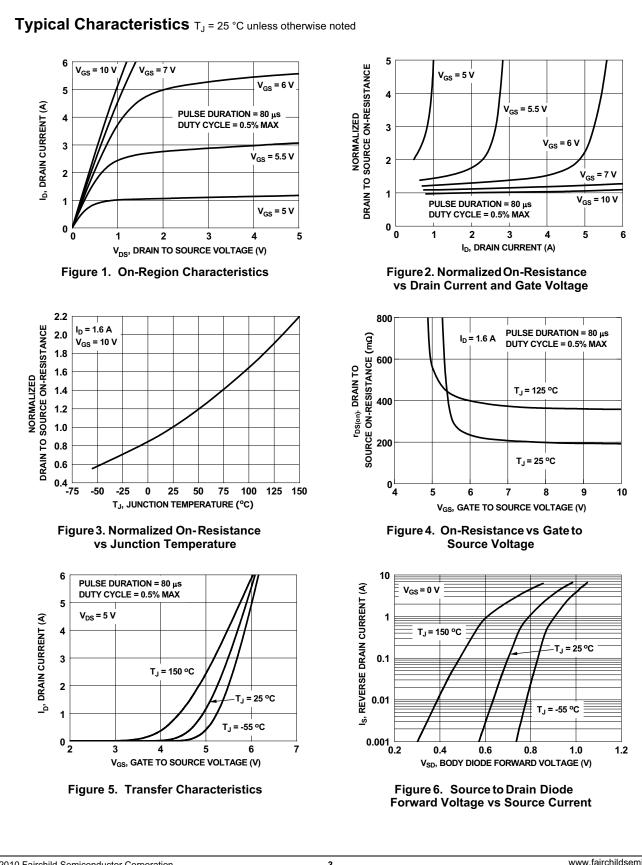
#### Swit

t <sub>d(on)</sub>	Turn-On Delay Time		4.5	10	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 1.6 A,	1.1	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{DD}$ = 75 V, I <sub>D</sub> = 1.6 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω	8	16	ns
t <sub>f</sub>	Fall Time		2.9	10	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V	2.9	5	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 75 V,$	1.6	3	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 1.6 A	0.9		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		0.8		nC

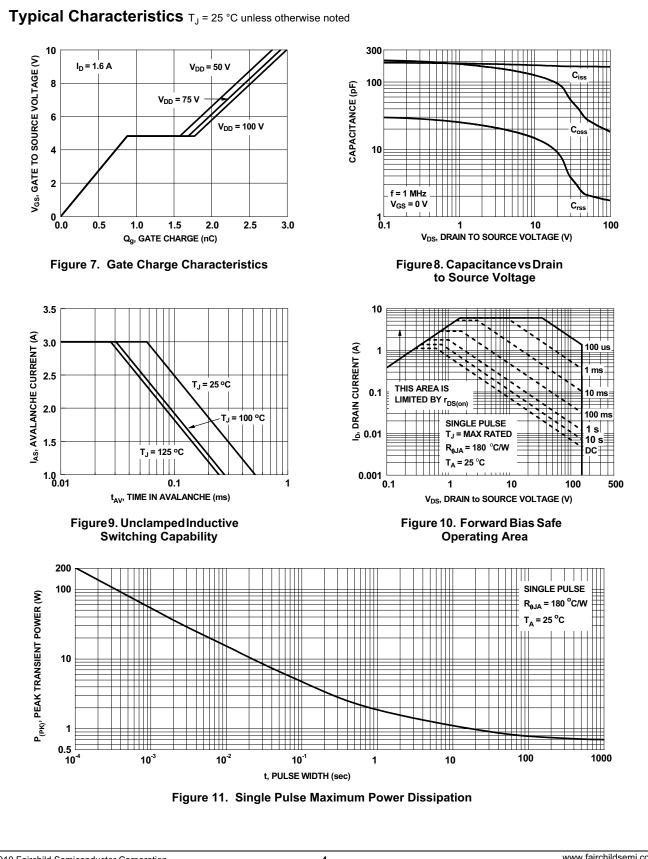
#### Drai

$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.6 A$ (Note 2)	0.83	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 1.6 A, di/dt = 100 A/μs		ns	
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 1.6 A, αι/αt = 100 A/μs 29 47		nC	

3. Starting T<sub>J</sub> = 25 °C; N-ch: L = 3 mH, I<sub>AS</sub> = 3 A, V<sub>DD</sub> = 150 V, V<sub>GS</sub> = 10 V.



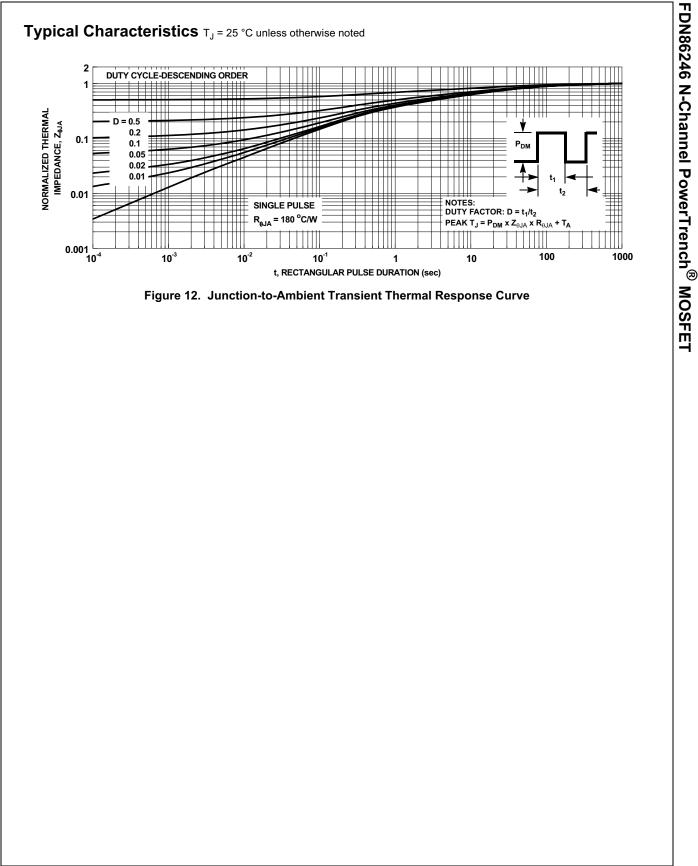
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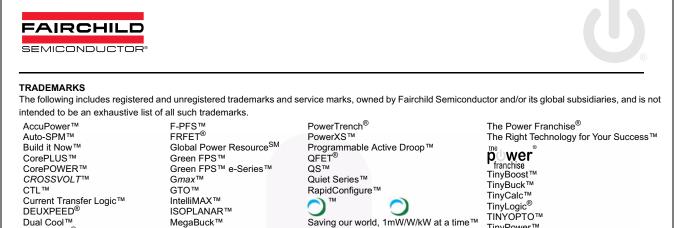


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FDN86246 N-Channel PowerTrench<sup>®</sup> MOSFET





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SmartMax™

STEALTH™

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SuperSOT™-6

SuperSOT™-8

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